

THERMISTOR SPECIFICATIONS

1. Scope

This specification defines rating, dimensions, electrical properties, mechanical properties and climatic properties for "AT" type thermistor.

2. Part No.

103AT-5

3. Rating

3.1 Rated zero-power resistance

R₂₅

10.0 kΩ ±1% (at 25°C)

3.2 Rated B-value

B_{25/85}

3 435 K

±1%

(The Rated B-value is calculated from the zero-power resistance

values measured at 25 $^{\circ}$ C and 85 $^{\circ}$ C.)

3.3 Dissipation factor

Approx. 2.5mW/ $^{\circ}$ (in still air at 25 $^{\circ}$)

(Measured at our lab, according to JIS C 2570 13.7/ IEC 60539)

3.4 Thermal time constant

Approx. 15 sec. (in still air)

(The time required for thermistor temperature to reach 63.2% of the differences between the initial temperature and ambient temperature when thermal equilibrium is plunged to the state of

zero power. Measured according to JIS C 2570 13.8)

3.5 Maximum power

12.5mW (in still air at 25℃)

(Including self-heat of approx. 5℃)

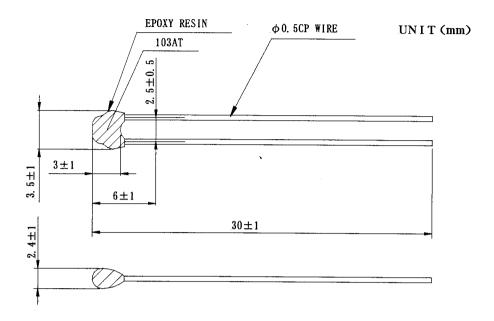
4. Operating temperature ranges

-50℃~110℃

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5. Dimensions



6. Electric properties

	Item	Test Conditions	Criteria
6.1	Voltage proof	AC 1 000V 1 min. or AC 1 200V 1 sec.	Cut-off current : 1mA
6.2	Insulation	DC 500V	Over100M Ω

All electric property tests are carried out between the top of the epoxy coat area and lead-wire

7. Mechanical properties

	Item	Test Conditions	Criteria
7.1	Robustness of Terminations	2N load for 3 sec. as per below: (8. 5) 2N (3 sec.)	Variation of resistance at 25 [°] C and Rated B-value after test shall be within ±1% of those of the initial values. No visible damage

Spec. NO.	001 0000
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	Item	Test Conditions	Criteria
7.2	Free fall	From 1 meter high to the maple or the like board	
7.3	Resistance to soldering heat	The lead-wires below more than 8.5mm from the top of the epoxy coating part shall be dipped in the soldering bath at 260°C±10°C for 5±1 sec. In case of a soldering iron, the 350°C±5°C of the iron shall be applied to the point of the lead-wire below more than 8.5mm from the top of the epoxy coating part less than 2 sec.	Variation of resistance at 25 [°] C and Rated B-value after test shall be within ±1% of those of the initial values.
7.4	Solderability	After applying the flux JIS C2570 specified, the lead-wires are to be dipped in the soldering bath at $235^{\circ}C \pm 5^{\circ}C$ for 2 ± 0.5 sec.	The soldered area shall be covered with the solder more than 90%.

8. Climatic properties

	Item	Test Conditions	Criteria
8-1	Dry Heat	At 110℃±3℃ for 1 000 hrs. and then in room temperature for 1 hour.	
8-2	Humidity	at 40℃±3℃, 90 to 95%RH for 1 000 hrs and then in room temperature for 1 hour	
8-3	High temperature load	at 110℃±3℃ with the DC 1mA load for 1 000 hrs and then in room temperature for 1 hour.	Variation of resistance at 25 $^{\circ}$ and
8-4	Humidity load	at 40℃±3℃, 90 to 95%RH with the DC 1mA load for 1 000 hrs and then in room temperature for 1 hour.	Rated B-value after test shall be within $\pm 1\%$ of those of the initial values.
8-5	Temperature Cycling	100 times in the following order and conditions and then in room temperature for 1 hour "Room temperature (Initial value)" $-30\%\pm3\%$ for 5 min" "Room temperature for 3 min". " $90\%\pm3\%$ for 5 min." "Room temperature for 3 min".	

9. Specified Brominated Flame Retardants

No prohibited materials, PBBE (Poly Bromo Phenyl Ethers) contained in.

10. Ozone-Depleting Substances

No prohibited materials, ODS (Class I, Class II) contained in.

Spec. NO.	S01·0302